

**Description**

The SX90N25MP is silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.

**General Features**

$V_{DS} = 280V$   $I_D = 90A$

$R_{DS(ON)} < 35m\Omega$  @  $V_{GS}=10V$

**Application**

Uninterruptible Power Supply(UPS)

Power Factor Correction (PFC)

**Absolute Maximum Ratings ( $T_c=25^\circ C$  unless otherwise noted)**

| Symbol         | Parameter  | Value    | Unit |
|----------------|--|----------|------|
| $VDSS$         | Drain-Source Voltage ( $V_{GS} = 0V$ )           | 280      | V    |
| $ID$           | Continuous Drain Current                         | 90       | A    |
| $IDM$          | Pulsed Drain Current                             | 360      | A    |
| $VGSS$         | Gate-Source Voltage                              | $\pm 20$ | V    |
| $EAS$          | Single Pulse Avalanche Energy                    | 2000     | mJ   |
| $IAS$          | Avalanche Current                                | 20       | A    |
| $EAR$          | Repetitive Avalanche Energy                      | 8        | mJ   |
| $P_D$          | Power Dissipation ( $T_c = 25^\circ C$ )         | 140      | W    |
| $T_J, T_{stg}$ | Operating Junction and Storage Temperature Range | -55~+150 | °C   |
| $R_{thJC}$     | Thermal Resistance, Junction-to-Case             | 0.89     | °C/W |
| $R_{thJA}$     | Thermal Resistance, Junction-to-Ambient          | 40       | °C/W |

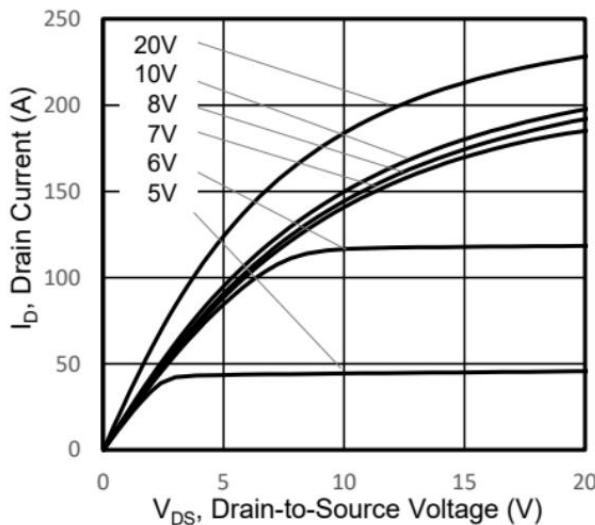
**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

| Parameter | Symbol                            | Test Conditions  | Min. | Typ. | Max.      | Units            |
|-----------|-----------------------------------|--|------|------|-----------|------------------|
| V(BR)DSS  | Drain-SourceBreakdown Voltage     | $V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$   | 280  | 300  | --        | V                |
| IDSS      | Zero Gate Voltage Drain Current   | $V_{DS} = 250\text{V}, V_{GS} = 0\text{V}, T_J = 25^\circ\text{C}$                         | --   | --   | 1         | $\mu\text{A}$    |
| IGSS      | Gate-Source Leakage               | $V_{GS} = \pm 30\text{V}$  | --   | --   | $\pm 100$ | nA               |
| VGS(th)   | Gate-Source Threshold Voltage     | $V_{DS}=V_{GS}, I_D = 250\mu\text{A}$  | 2.0  | 3.0  | 4.0       | V                |
| RDS(on)   | Drain-SourceOn-Resistance (Note3) | $V_{GS}=10\text{V}, I_D = 40\text{A}$  | --   | 30   | 35        | $\text{m}\Omega$ |
| Ciss      | Input Capacitance                 | $V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = .0\text{MHz}$                                | --   | 5784 | --        | pF               |
| Coss      | Output Capacitance                |  | --   | 893  | --        |                  |
| Crss      | Reverse Transfer Capacitance      |  | --   | 561  | --        |                  |
| Qg        | Total Gate Charge                 | $V_{DD} = 200\text{V}, I_D = 80\text{A}, V_{GS} = 10\text{V}$                              | --   | 376  | --        | nC               |
| Qgs       | Gate-Source Charge                |  | --   | 33.8 | --        |                  |
| Qgd       | Gate-Drain Charge                 |  | --   | 177  | --        |                  |
| td(on)    | Turn-on Delay Time                | $V_{DD} = 125\text{V}, I_D = 80\text{A}, R_G = 25\Omega$                                   | --   | 55   | --        | ns               |
| tr        | Turn-on Rise Time                 |  | --   | 165  | --        |                  |
| td(off)   | Turn-off Delay Time               |  | --   | 1050 | --        |                  |
| tf        | Turn-off Fall Time                |  | --   | 367  | --        |                  |
| IS        | Continuous Body Diode Current     | $T_C = 25^\circ\text{C}$   | --   | --   | 90        | A                |
| ISM       | Pulsed Diode Forward Current      |  | --   | --   | 320       | A                |
| VSD       | Body Diode Voltage                | $T_J = 25^\circ\text{C}, I_{SD} = 22.5\text{A}, V_{GS} = 0\text{V}$                        | --   | --   | 1.4       | V                |
| trr       | Reverse Recovery Time             | $V_{DD}=125\text{V} V_{GS} = 0\text{V}, I_S = 30\text{A}, dI/dt = 100\text{A}/\mu\text{s}$ | --   | 360  | --        | ns               |
| Qrr       | Reverse Recovery Charge           |  | --   | 5.61 | --        | $\mu\text{C}$    |

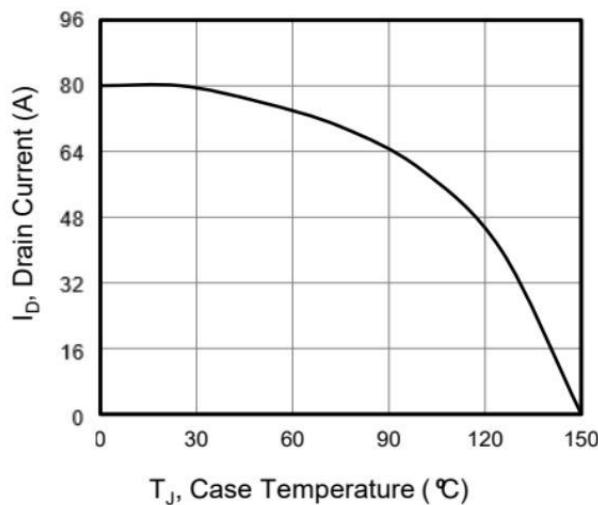
**Note :**

- 1、The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2、The EAS data shows Max. rating . IAS = 20A, VDD = 50V, RG = 25 Ω, Starting TJ = 25 °C
- 3、The test condition is Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%
- 4、The power dissipation is limited by 150°C junction temperature
- 5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

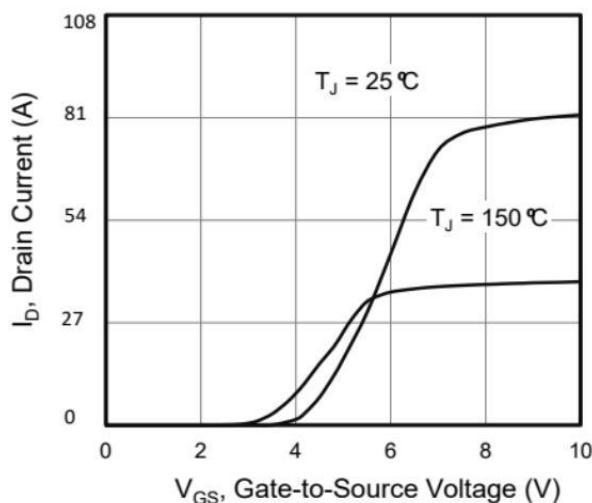
## Typical Characteristics



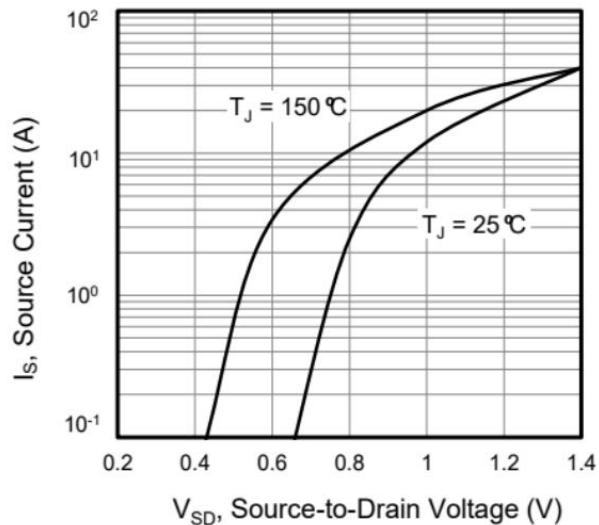
**Figure 1. Output Characteristics**



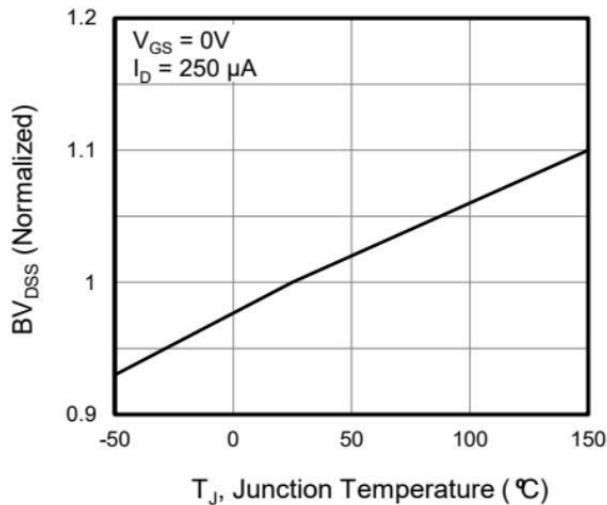
**Figure3. Drain Current vs. Temperature**



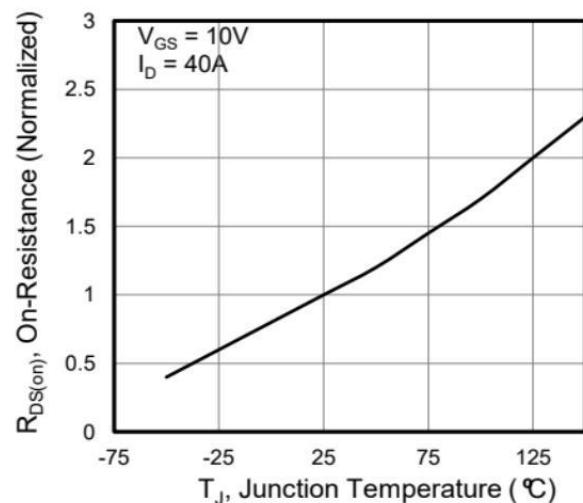
**Figure 5. Transfer Characteristics**



**Figure 2. Body Diode Forward Voltage**



**Figure4. BVDSS Variation vs. Temperature**



**Figure 6. On-Resistance vs. Temperature**

## Typical Characteristics

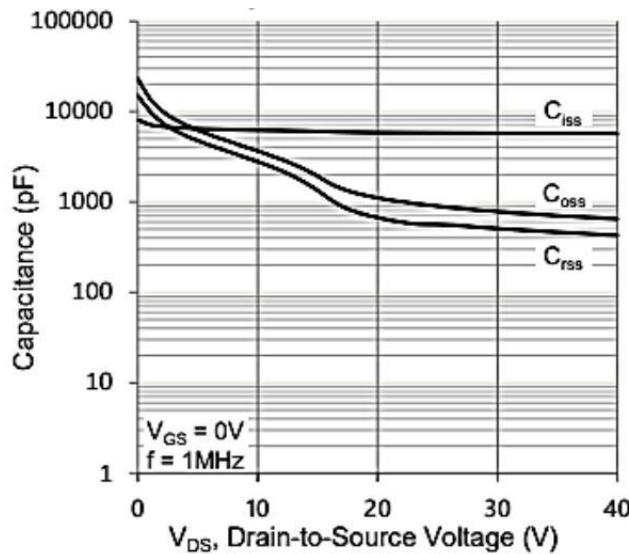


Figure 7. Capacitance

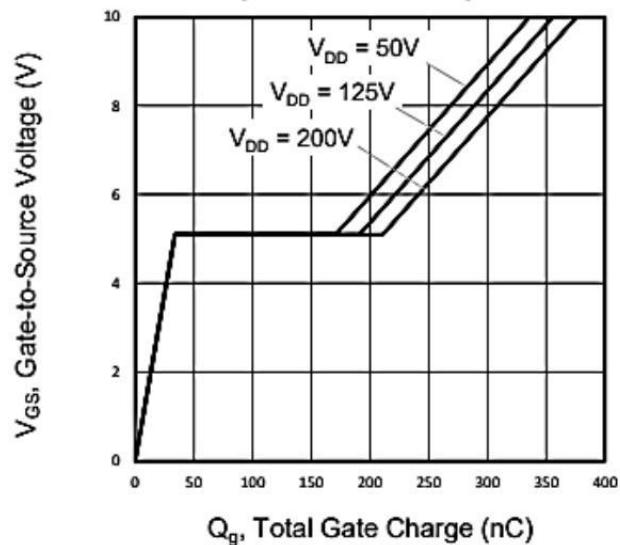


Figure 8. Gate Charge

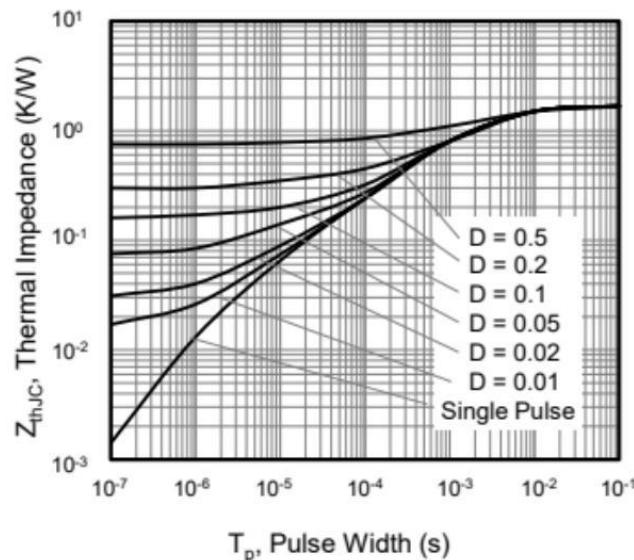
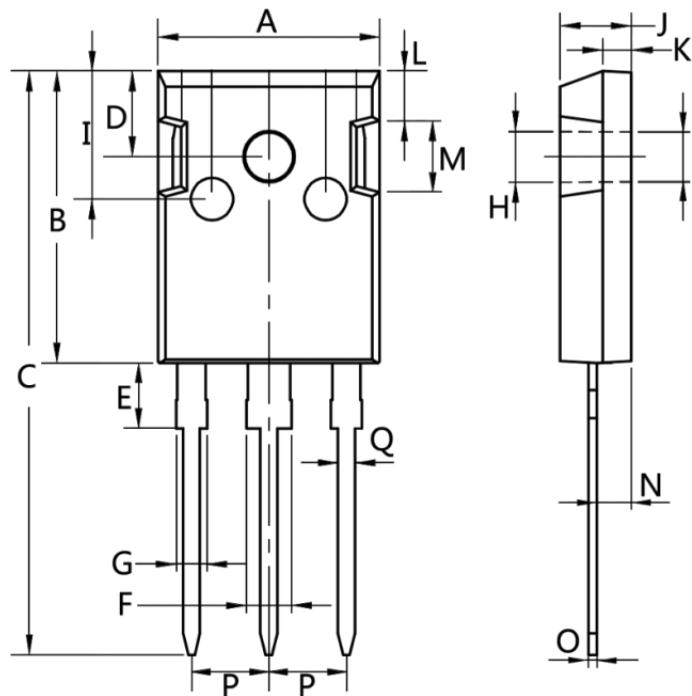


Figure 9. Transient Thermal Impedance

## Package Mechanical Data-TO-247-3L



| Dim. | Min.     | Max. |
|------|----------|------|
| A    | 15.0     | 16.0 |
| B    | 20.0     | 21.0 |
| C    | 41.0     | 42.0 |
| D    | 5.0      | 6.0  |
| E    | 4.0      | 5.0  |
| F    | 2.5      | 3.5  |
| G    | 1.75     | 2.5  |
| H    | 3.0      | 3.5  |
| I    | 8.0      | 10.0 |
| J    | 4.9      | 5.1  |
| K    | 1.9      | 2.1  |
| L    | 3.5      | 4.0  |
| M    | 4.75     | 5.25 |
| N    | 2.0      | 3.0  |
| O    | 0.55     | 0.75 |
| P    | Typ 5.08 |      |
| Q    | 1.2      | 1.3  |

### Package Marking and Ordering Information

| Product ID | Pack      | Marking | Qty(PCS) |
|------------|-----------|---------|----------|
| TAPING     | TO-247-3L |         | 330      |